

FIG. 1

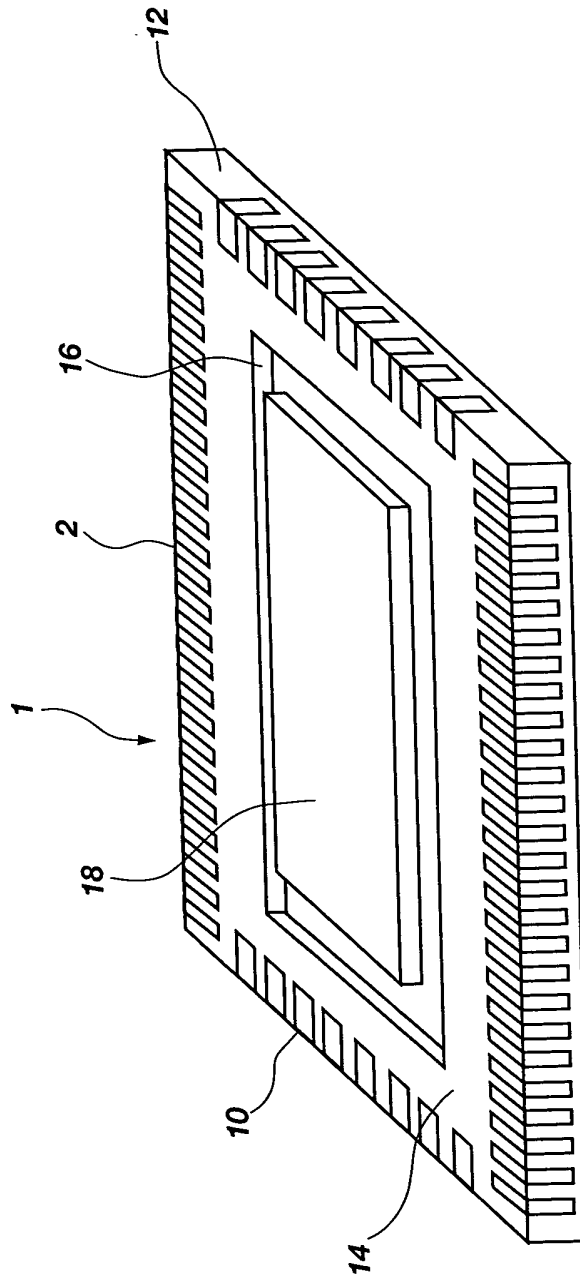
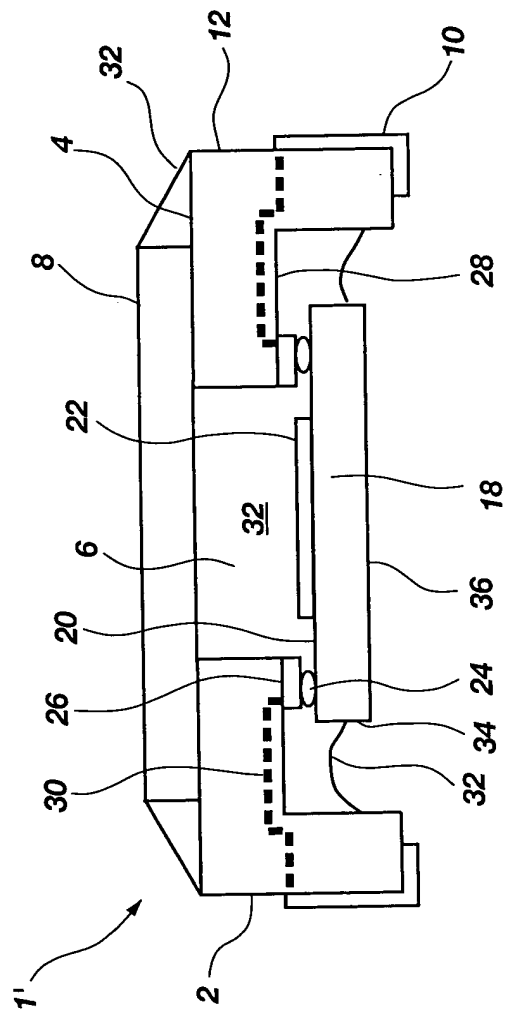
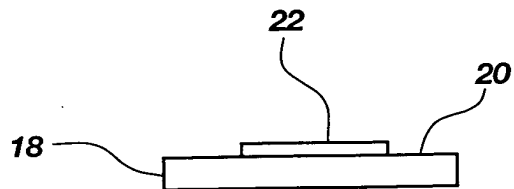


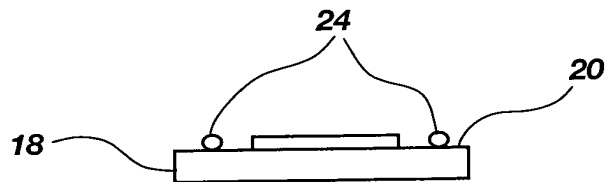
FIG. 2



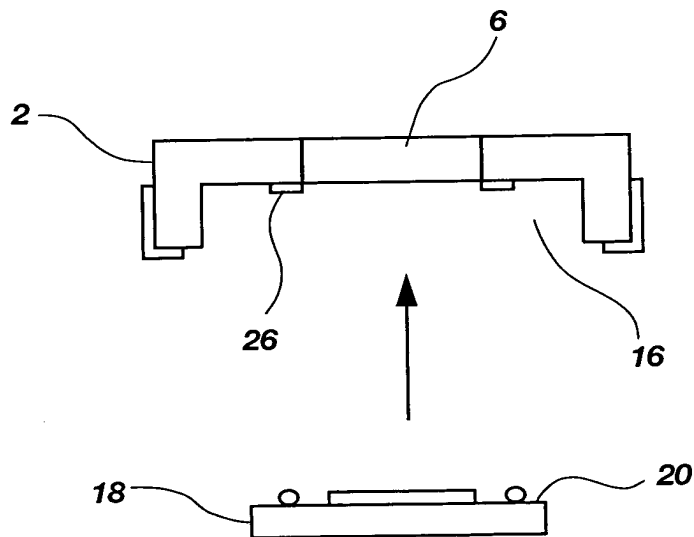
**FIG. 4**



**FIG. 5A**



**FIG. 5B**



**FIG. 5C**

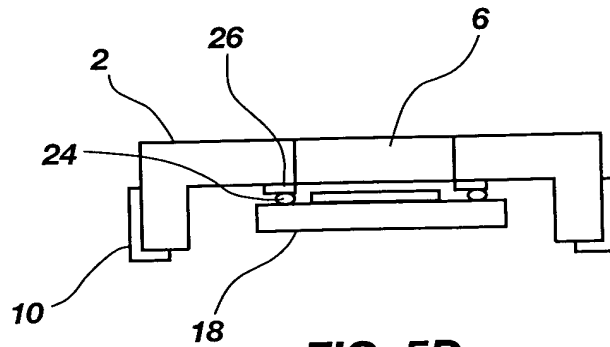


FIG. 5D

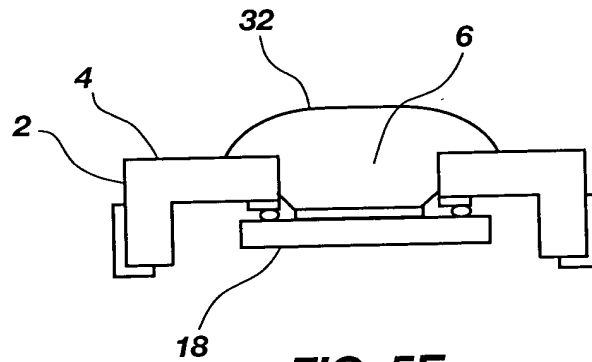


FIG. 5E

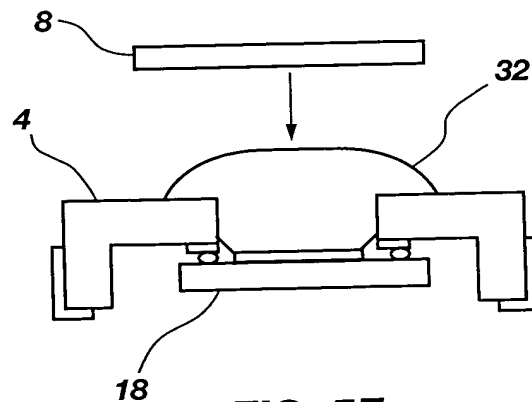


FIG. 5F



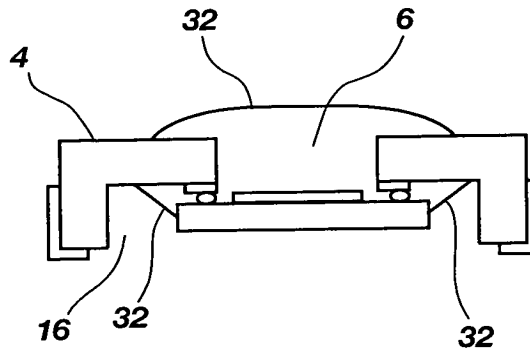
TITLE: LEADLESS PACKAGING FOR IMAGE SENSOR DEVICES  
AND METHODS OF ASSEMBLY

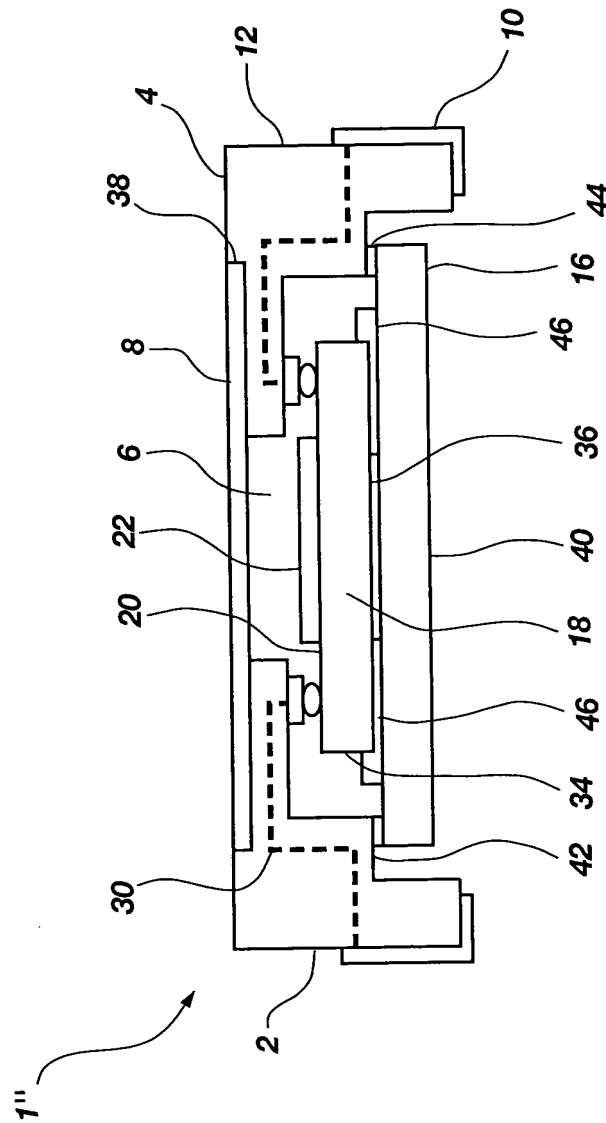
Inventor: Suan Jeung Boon

Serial No.: Not yet assigned

Docket No.: 5353.1US (02-0240.01/US)

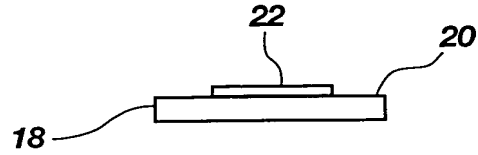
7/11



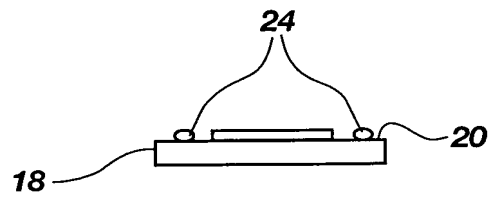


**FIG. 6**

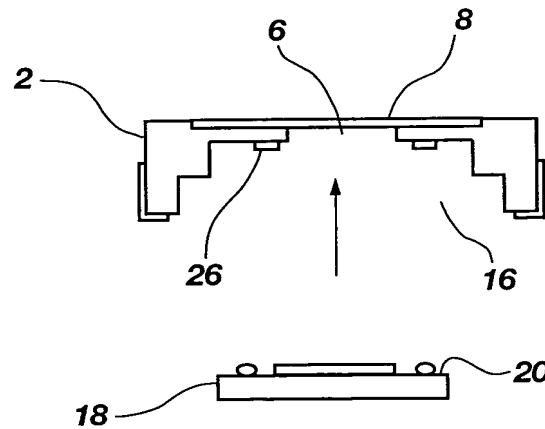




**FIG. 7A**

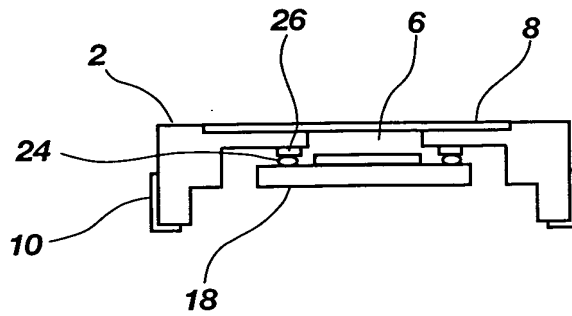


**FIG. 7B**

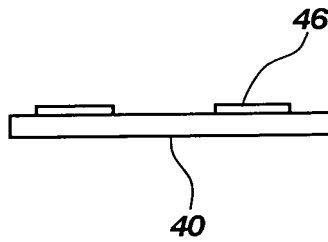


**FIG. 7C**

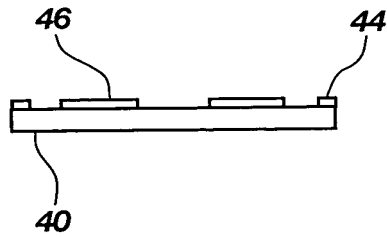
+



**FIG. 7D**

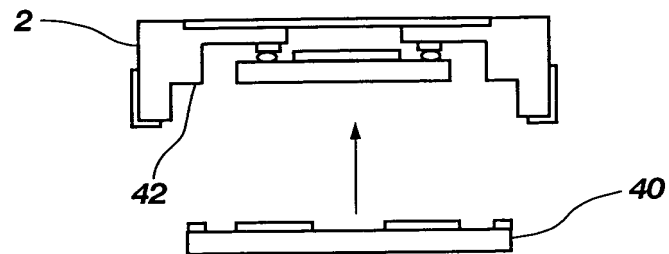


**FIG. 7E**

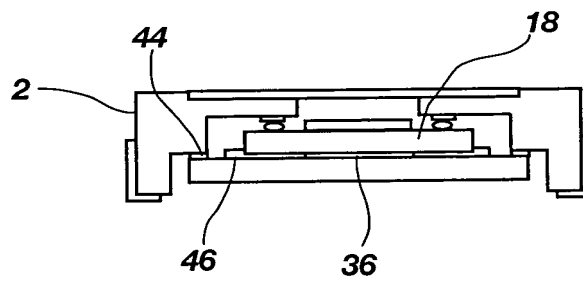


**FIG. 7F**

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**FIG. 7G**



**FIG. 7H**